



N-Channel 75-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
75	0.0068 at V _{GS} = 10 V	90 ^d	75	

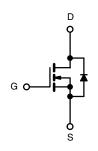
FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



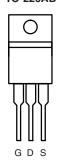
APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- Industrial



N-Channel MOSFET

TO-220AB



Top View

Ordering Information: SUP90N08-6m8P-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V _{DS}	75	V				
Gate-Source Voltage	V _{GS}	± 22	ľ				
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I-	90 ^d	A			
Continuous Diain Current (1) = 175 C)	T _C = 70 °C	I _D	90 ^d				
Pulsed Drain Current	I _{DM}	240					
Avalanche Current		I _{AS}			50		
Single Avalanche Energy ^a	L = 0.1 mH		125	mJ			
Maximum Power Dissipation ^a	T _C = 25 °C	P _D	272 ^b	w			
	T _A = 25 °C ^c		3.75				
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.55			

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When Mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUP90N08-6m8P

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SPECIFICATIONS $T_J = 25^{\circ}$	1					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static			I		T I	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	75			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA
Zero Gate Voltage Drain Current		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$			1	
	I _{DSS}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	μΑ
		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 20 A		0.0056	0.0068	Ω
	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.009	0.011	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		50		S
Dynamic ^b	•			•		
Input Capacitance	C _{iss}			4620		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V}, f = 1 \text{ MHz}$		517		
Reverse Transfer Capacitance	C _{rss}			247		
Total Gate Charge ^c	Q_g			75	115	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		25.5		
Gate-Drain Charge ^c	Q_{gd}			20		
Gate Resistance	R_{g}	f = 1 MHz		1.2	2.4	Ω
Turn-On Delay Time ^c	t _{d(on)}			16	30	
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V, R}_{L} = 0.6 \Omega$		11	20	ns ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		24	40	
Fall Time ^c	t _f			10	20	
Source-Drain Diode Ratings and Ch	aracteristics 7	r _C = 25 °C ^b				
Continuous Current	Is				85	
Pulsed Current	I _{SM}				240	Α
Forward Voltage ^a	V _{SD}	I _F = 20 A, V _{GS} = 0 V		0.83	1.5	V
Reverse Recovery Time	t _{rr}			60	100	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 75 A, dl/dt = 100 A/μs		3.3	4.5	Α
Reverse Recovery Charge	Q _{rr}			100	150	nC

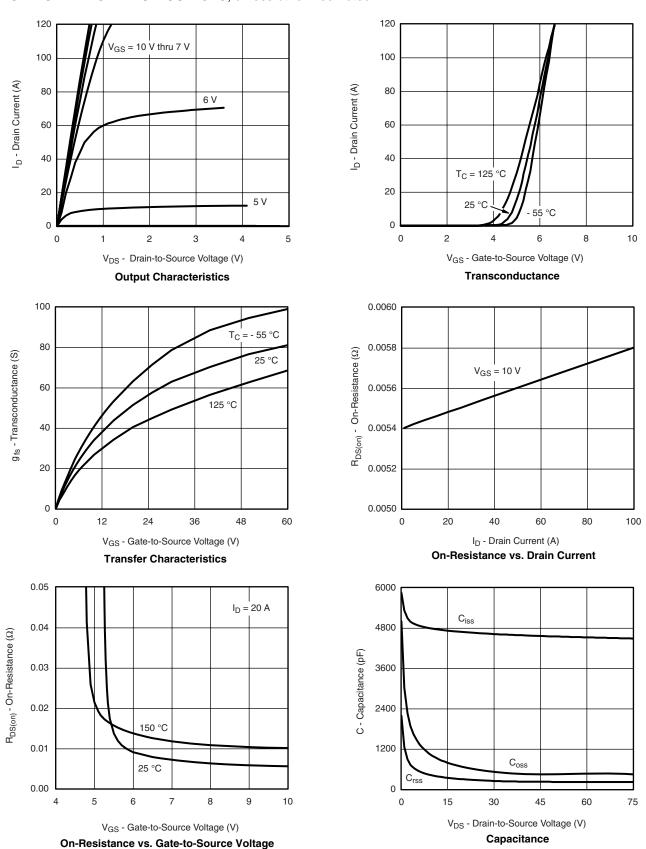
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



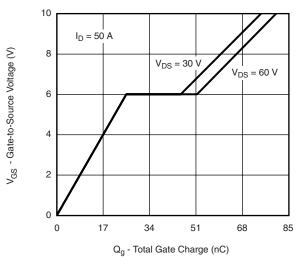
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



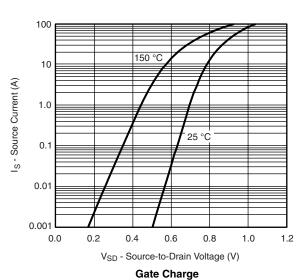
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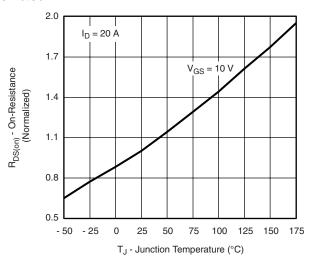
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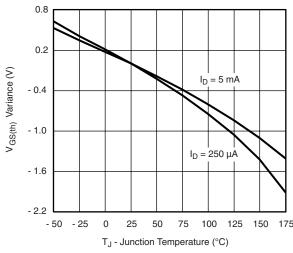
On-Resistance vs. Junction Temperature



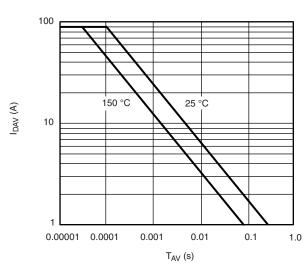
 $\label{eq:TJ-Junction} T_{J} \text{ - Junction Temperature (°C)}$ Source-Drain Diode Forward Voltage



Threshold Voltage



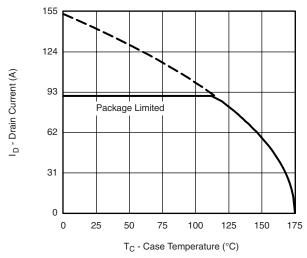
On-Resistance vs. Junction Temperature

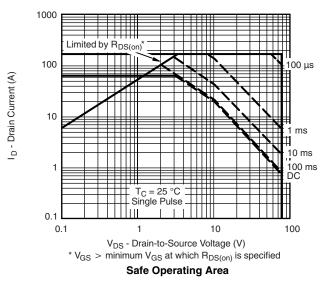


Single Pulse Avalanche Current Capability vs. Temperature

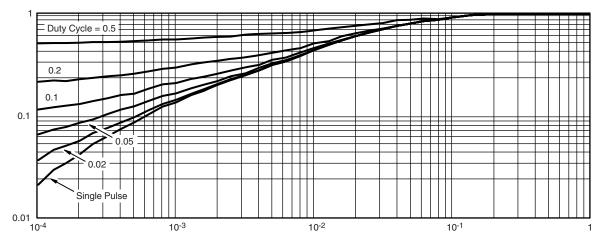
Normalized Effective Transient Thermal Impedance Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Avalanche Current Capability vs. Time



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

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